



US00D967068S

(12) **United States Design Patent** (10) **Patent No.:** **US D967,068 S**
Wen (45) **Date of Patent:** **** Oct. 18, 2022**

(54) **EARPHONE**

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(**) Term: **15 Years**

(21) Appl. No.: **29/763,486**

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(30) **Foreign Application Priority Data**

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(51) **LOC (13) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**
USPC D14/204, 205, 206, 223, 224, 225, 249,
D14/372, 433, 138 R, 188, 192, 172,
D14/203.1, 191, 496; D29/112; D28/41;
D13/118, 108, 119

CPC H04R 25/00; H04R 25/02; H04R 1/08;
H04R 1/10; H04R 1/1016; H04R 1/105;
H04R 1/1033; H04R 1/1083; H04R 1/02;

(Continued)

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(57) **CLAIM**

The ornamental design for an earphone, as shown and
described.

DESCRIPTION

FIG. 1 is a front, left, and top perspective view of a first
embodiment of an earphone, showing my design.

FIG. 2 is a rear, right, and bottom perspective view thereof.

FIG. 3 is a front elevation view thereof.

FIG. 4 is a rear elevation view thereof.

FIG. 5 is a left side elevation thereof.

FIG. 6 is a right side elevation thereof.

FIG. 7 is a top plan view thereof.

FIG. 8 is a bottom plan view thereof.

FIG. 9 is a front, right, and top perspective view of a second
embodiment of an earphone, showing my design.

FIG. 10 is a rear, left, and bottom perspective view thereof.

FIG. 11 is a front elevation view thereof.

FIG. 12 is a rear elevation view thereof.

FIG. 13 is a left side elevation thereof.

FIG. 14 is a right side elevation thereof.

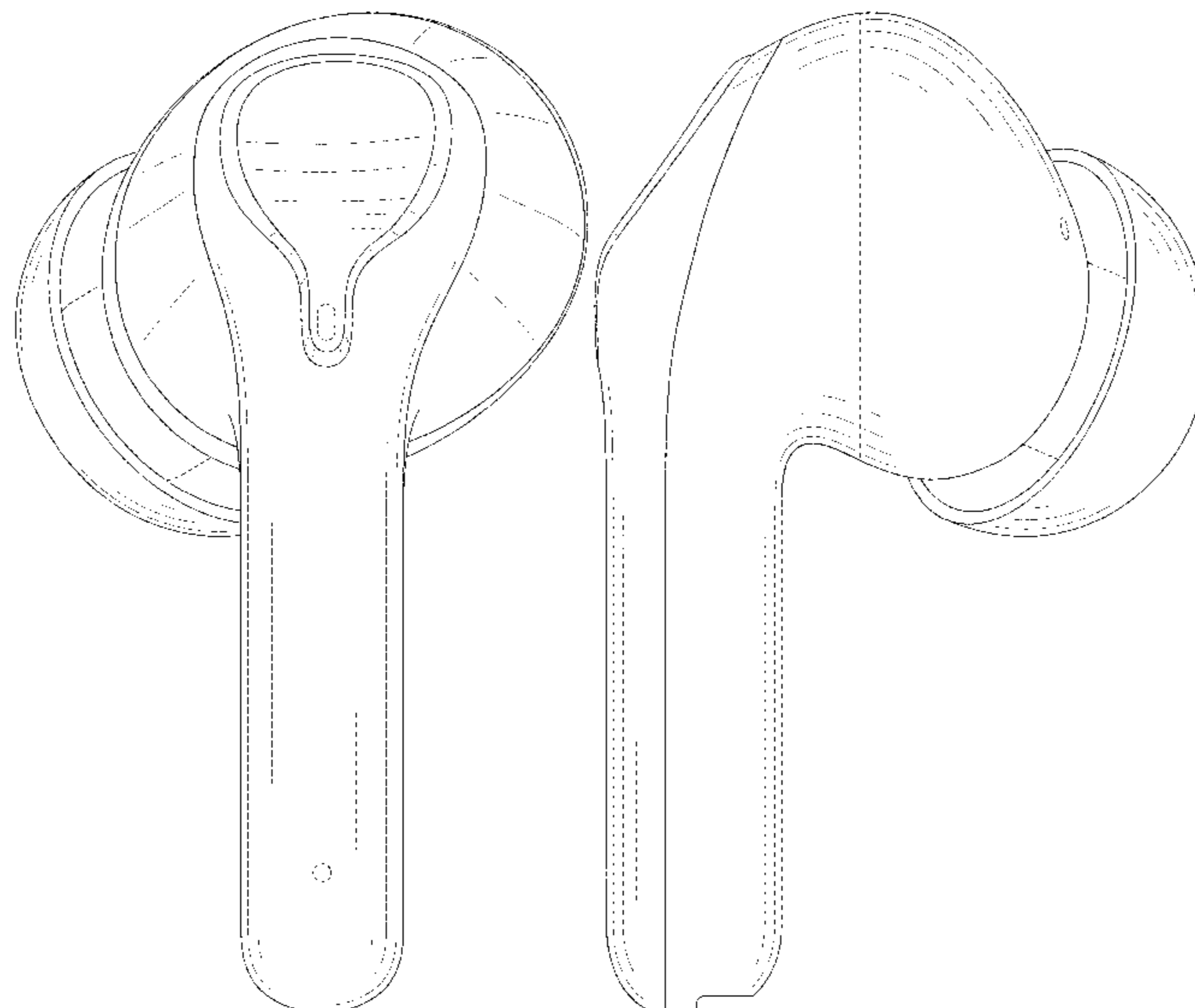
FIG. 15 is a top plan view thereof.

FIG. 16 is a bottom plan view thereof; and,

FIG. 17 is a combination of the first and second embodi-
ments of an earphone.

The broken lines shown in the drawings are included for the
purpose of illustrating portions of the earphone that form no
part of the claimed design.

1 Claim, 17 Drawing Sheets



(58) **Field of Classification Search**

CPC H04R 1/1041; H04R 1/28; H04R 5/033;
H04R 5/0335

See application file for complete search history.

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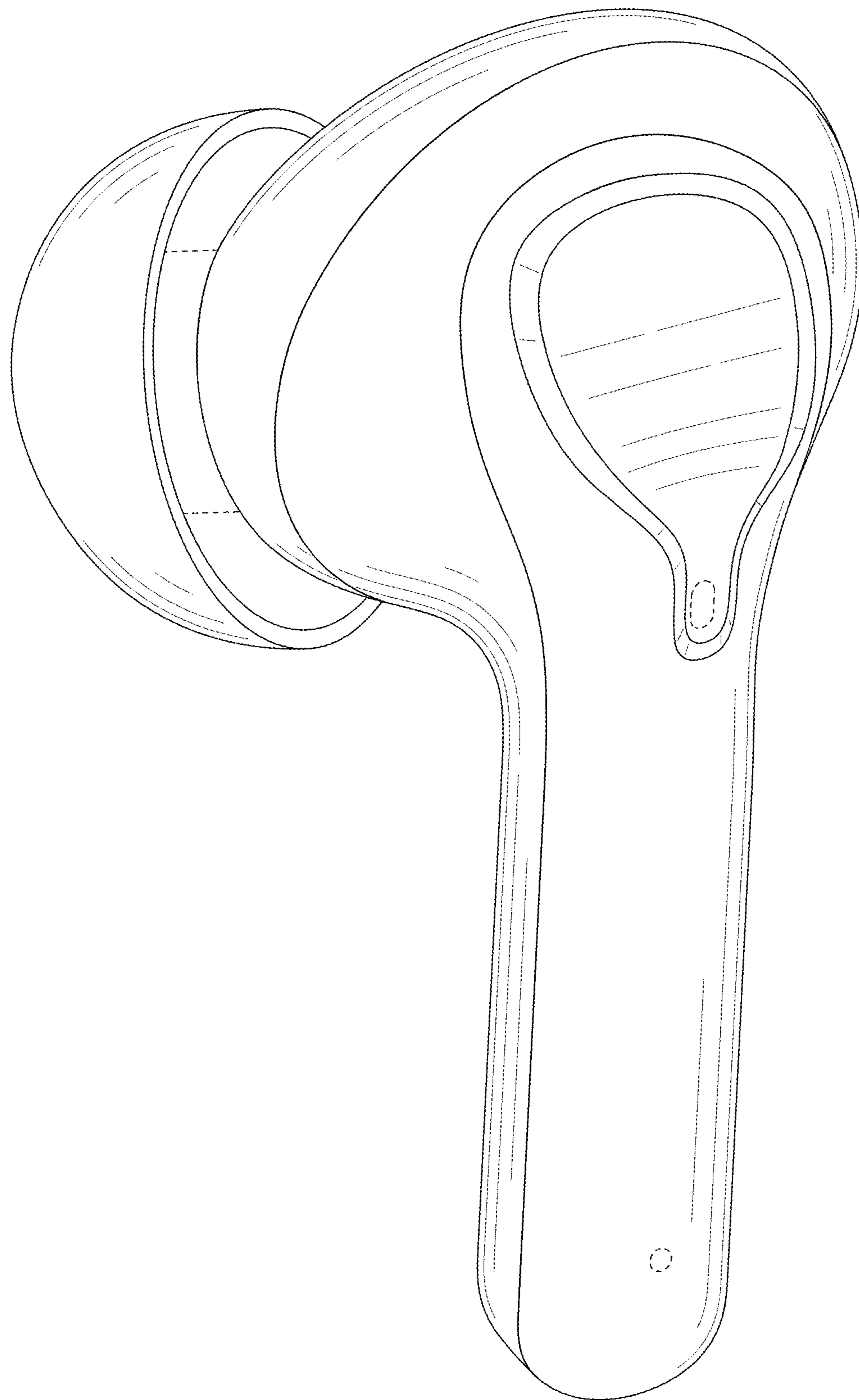


FIG. 1

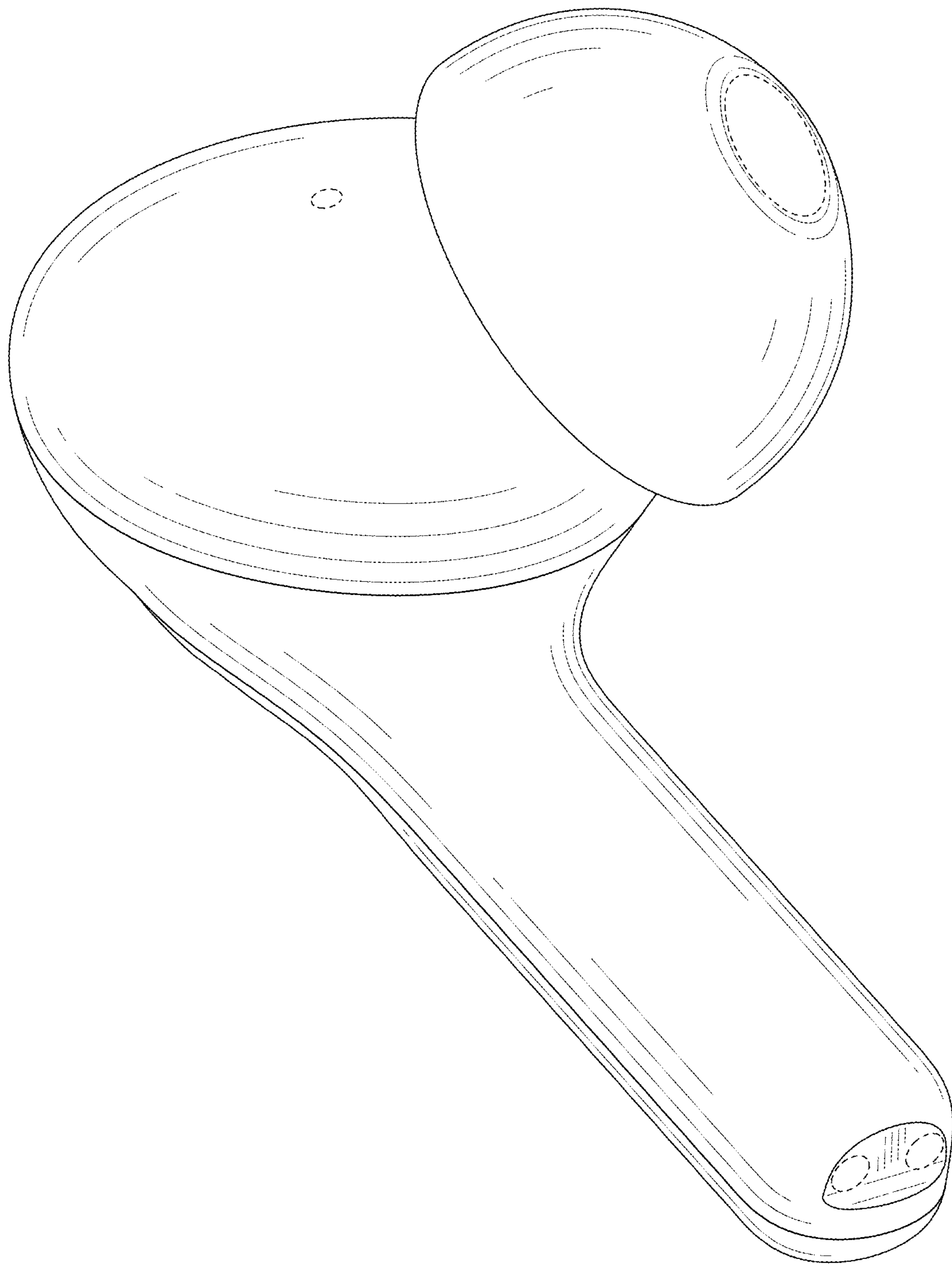


FIG. 2

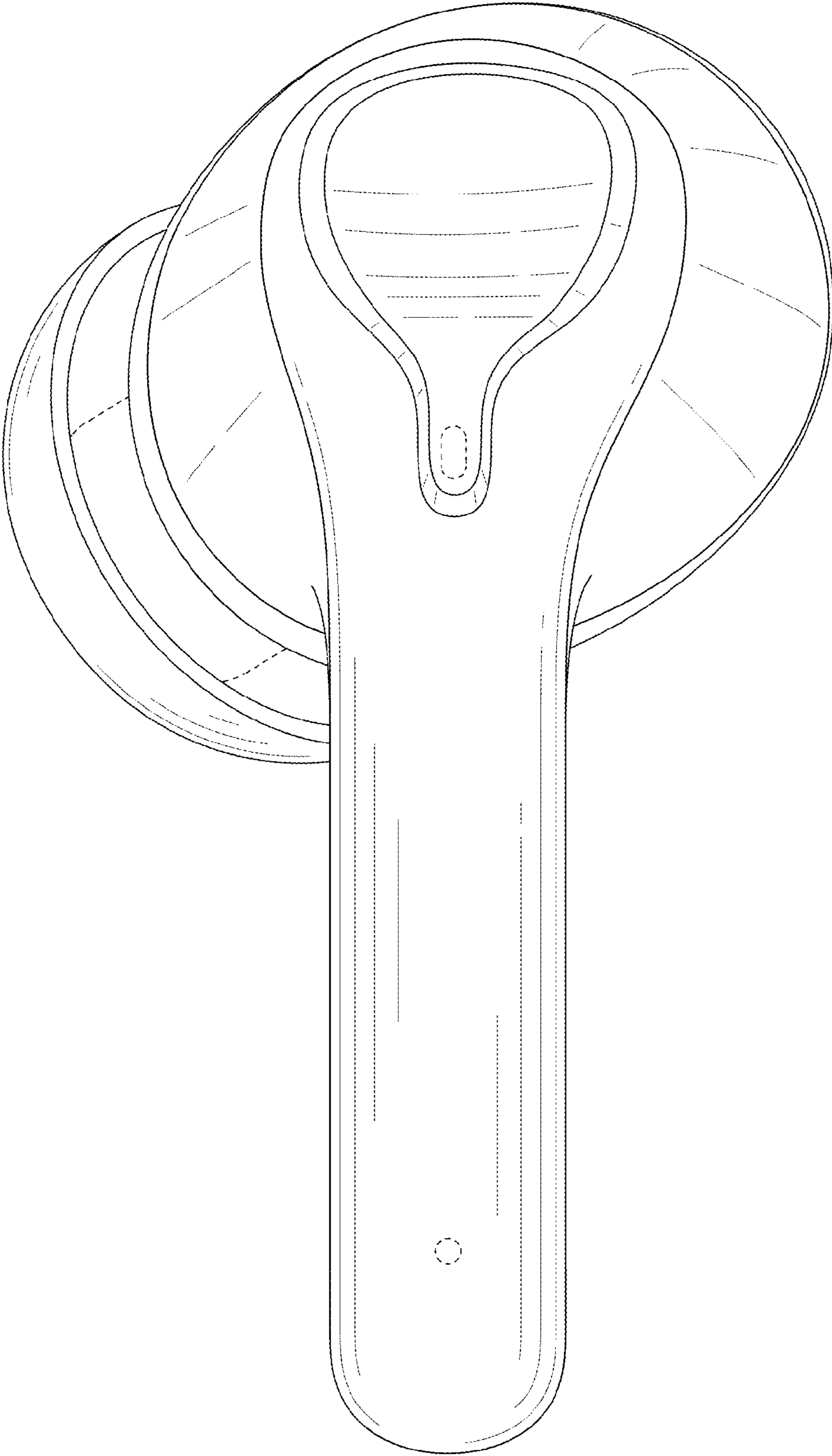


FIG. 3

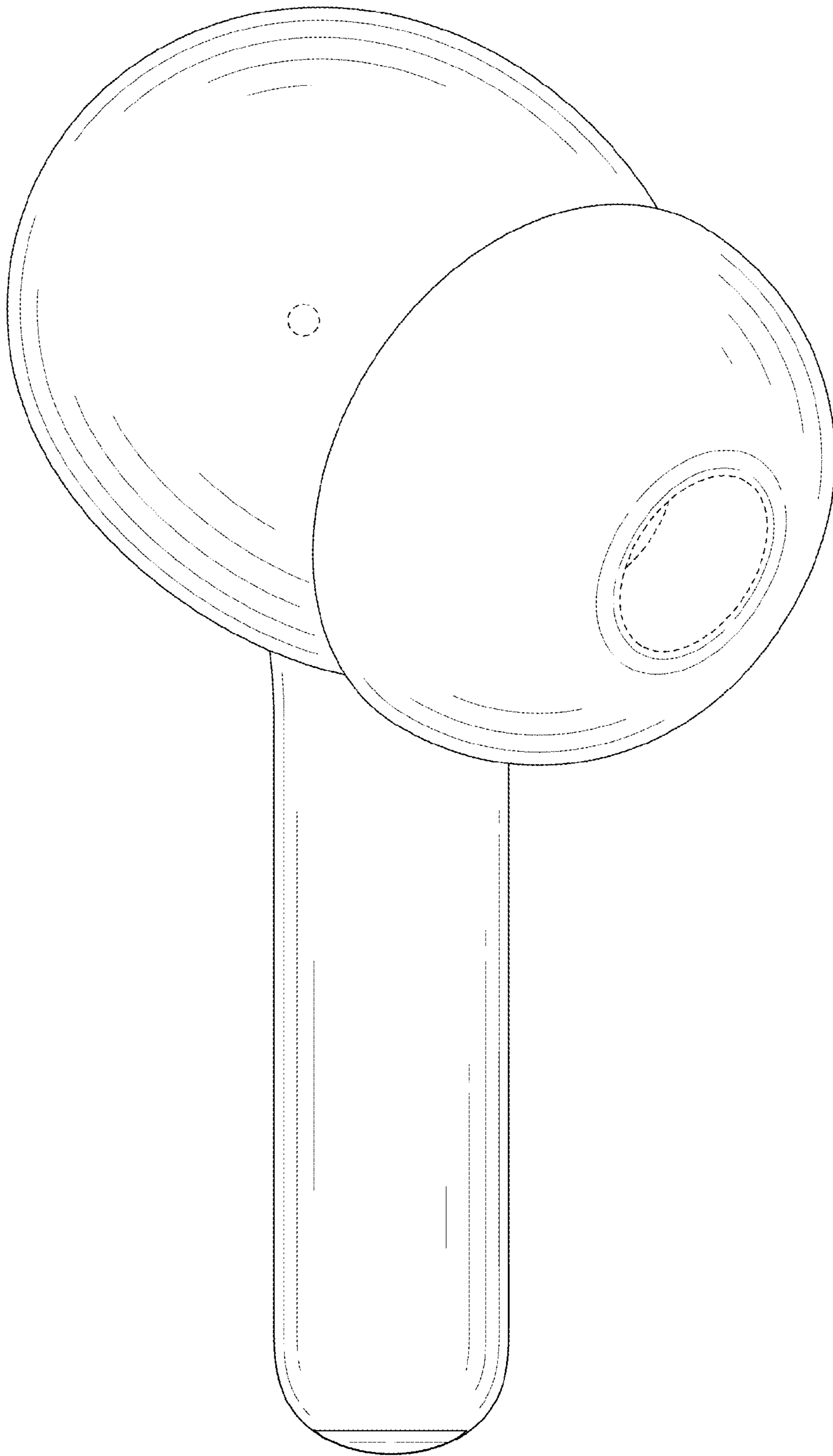


FIG. 4

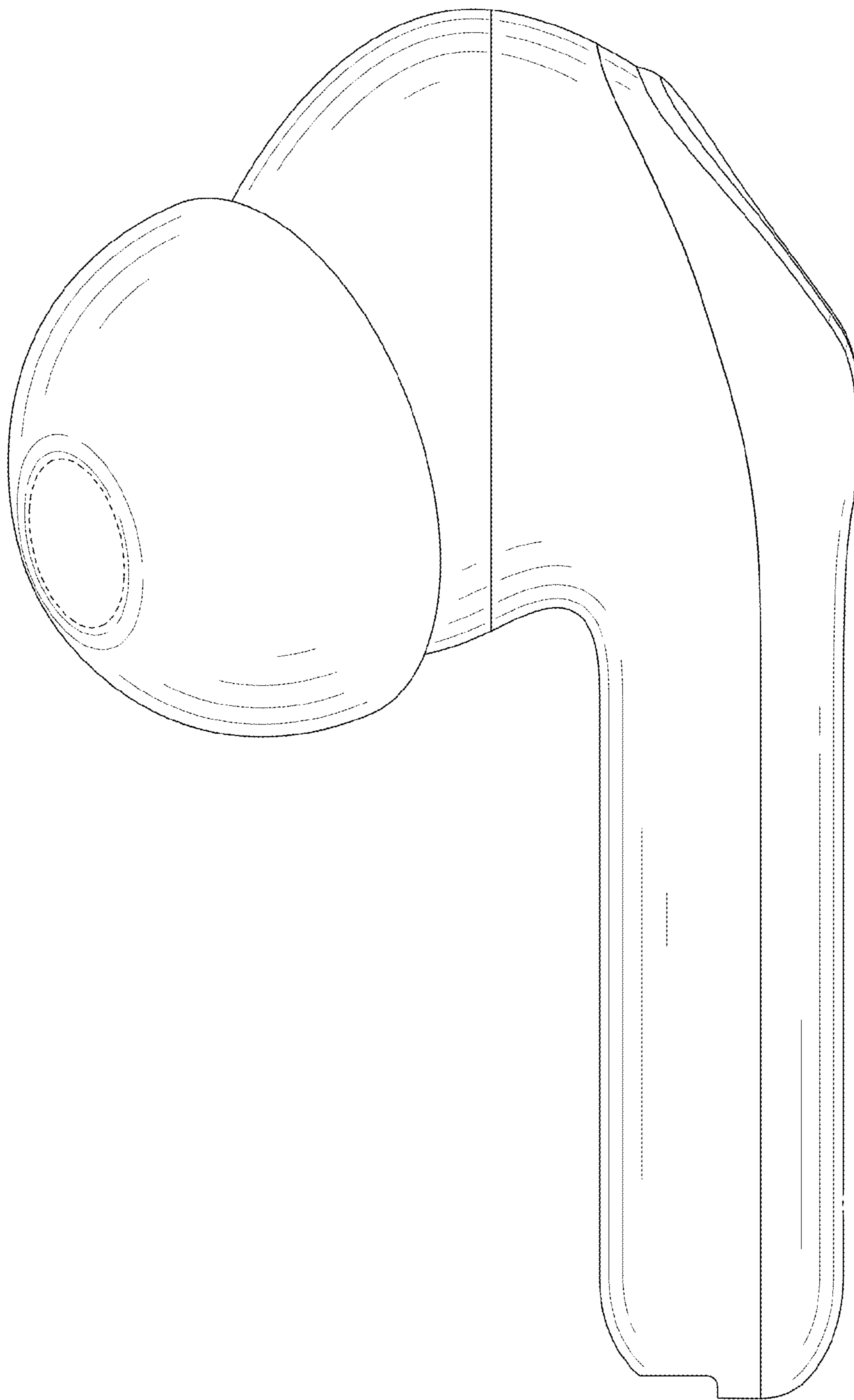


FIG. 5

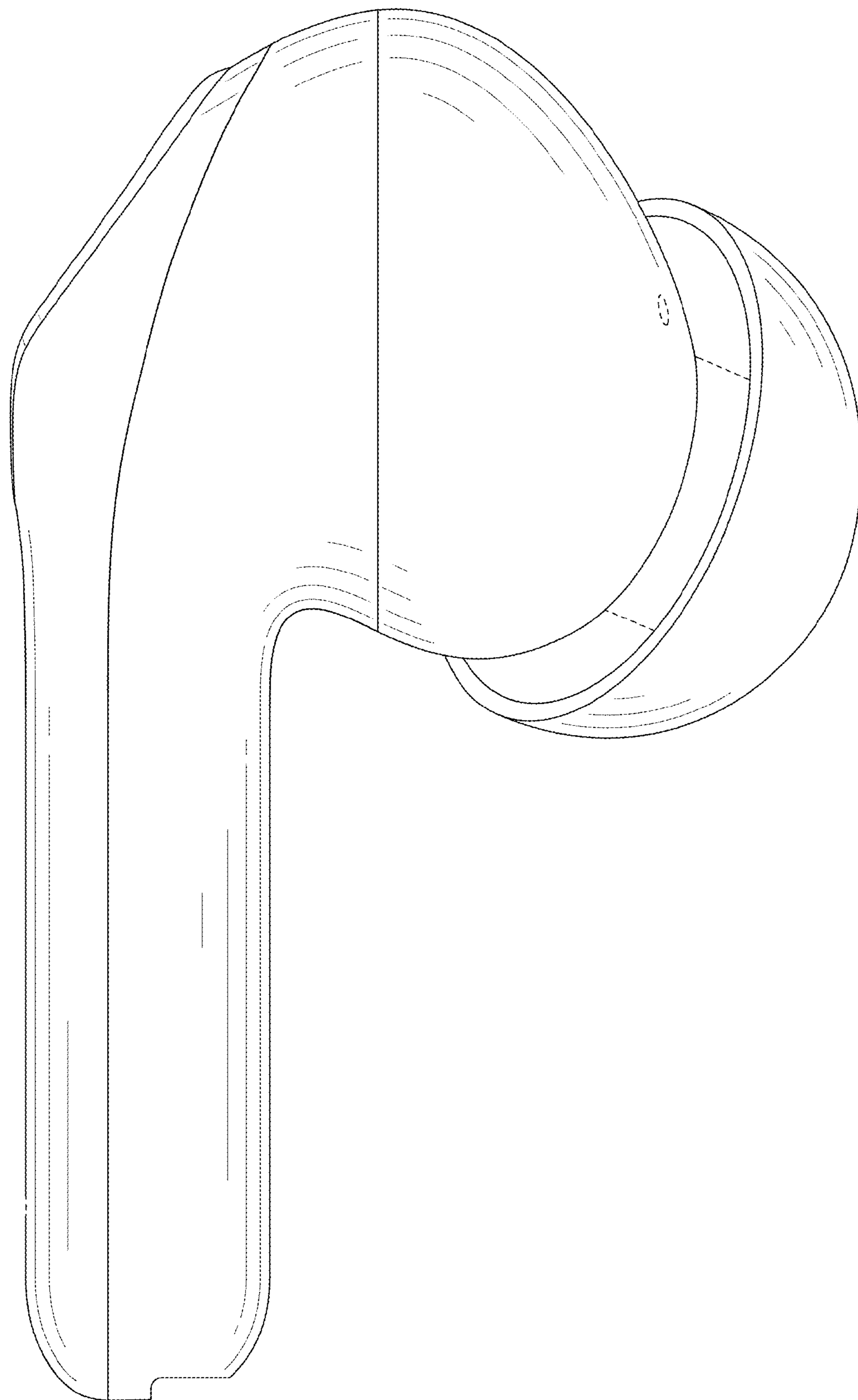


FIG. 6

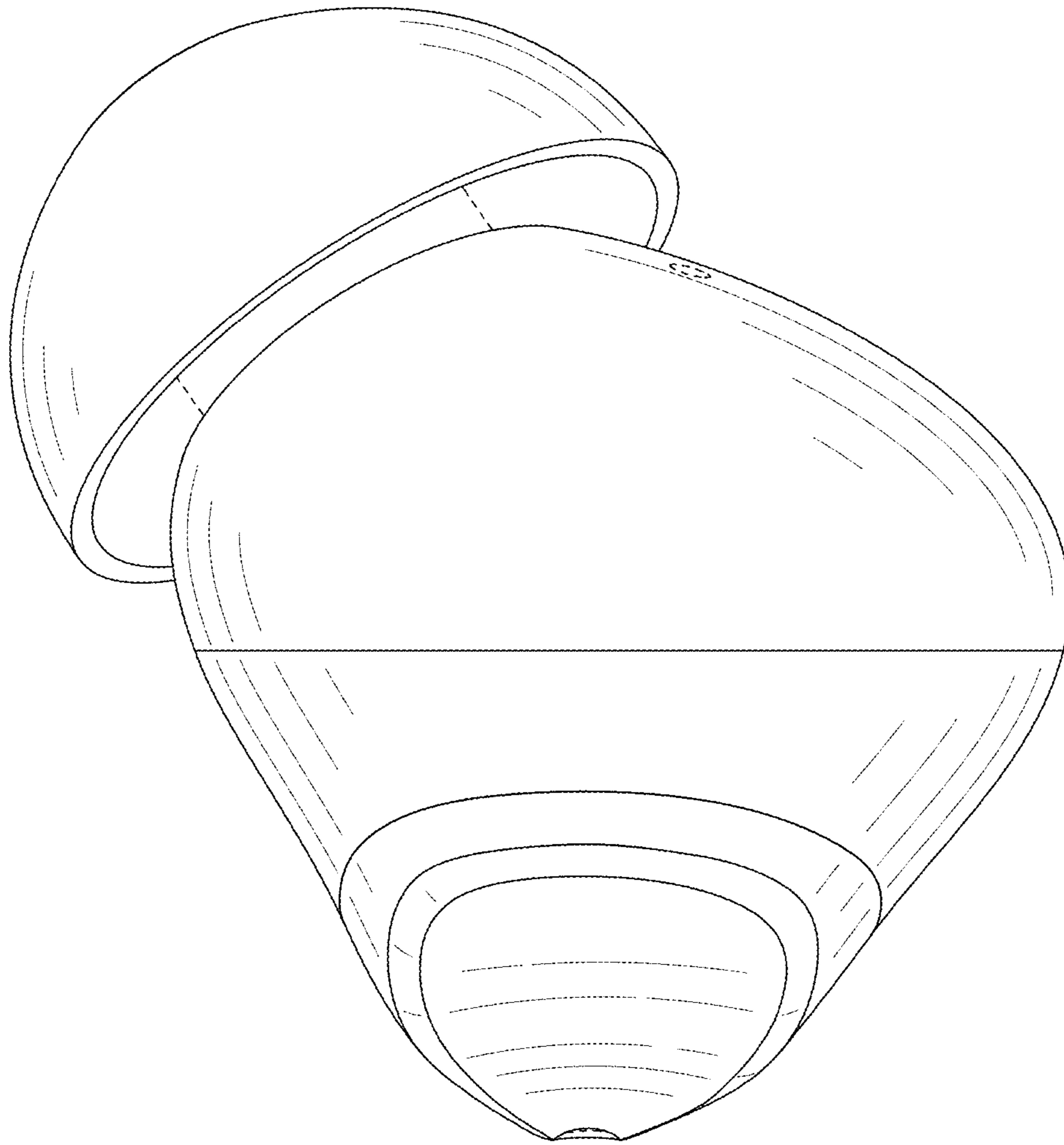


FIG. 7

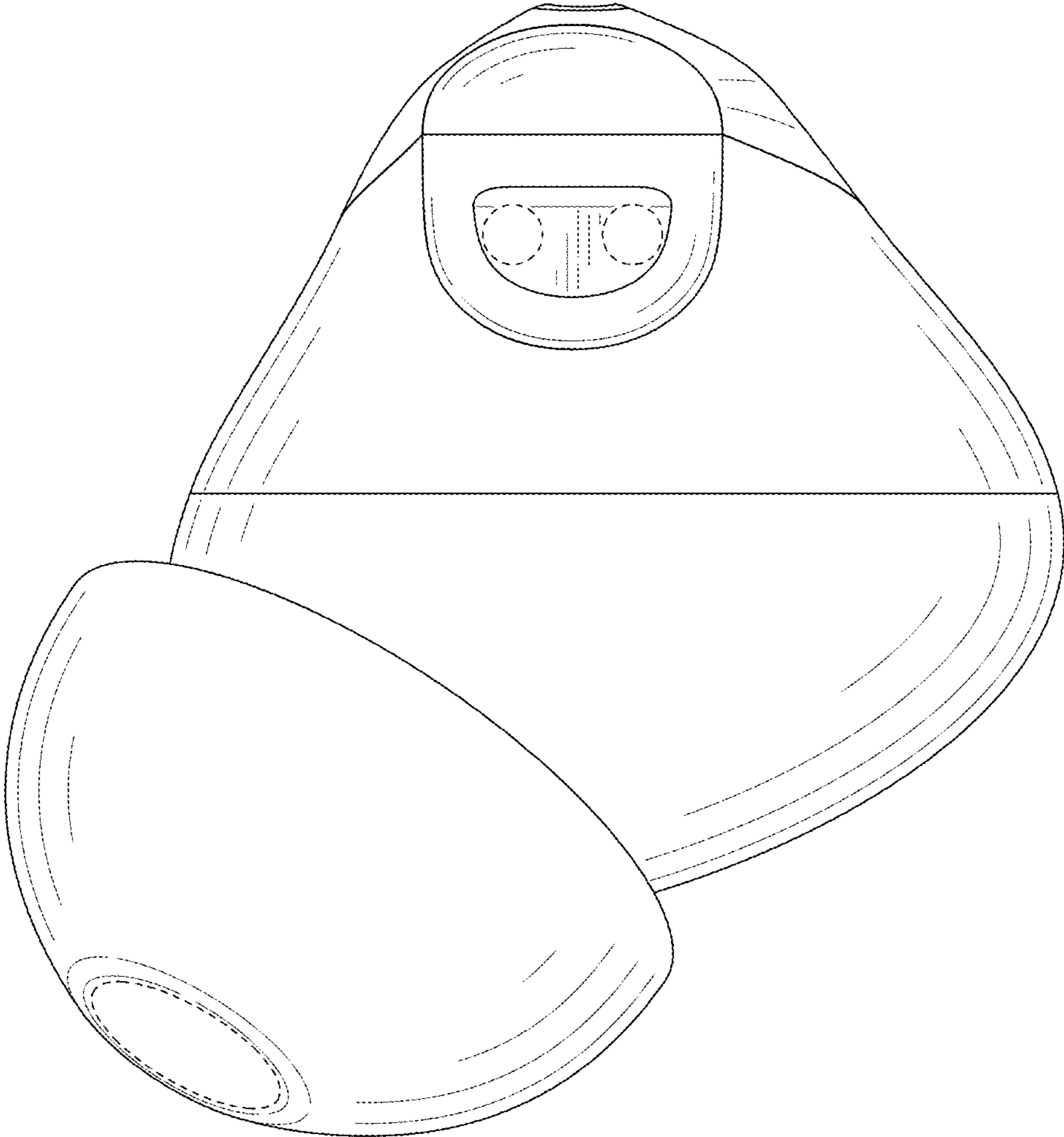


FIG. 8

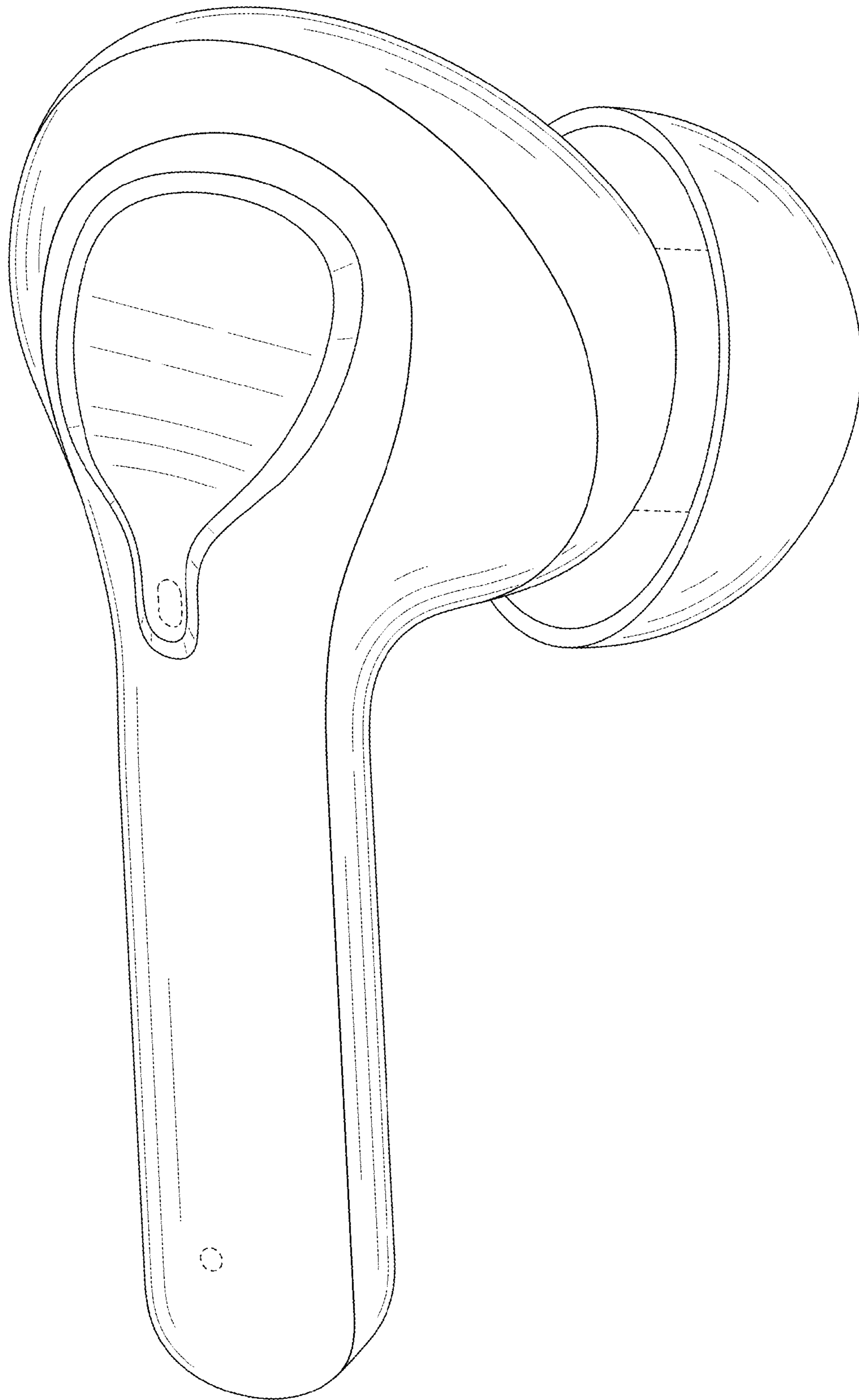


FIG. 9

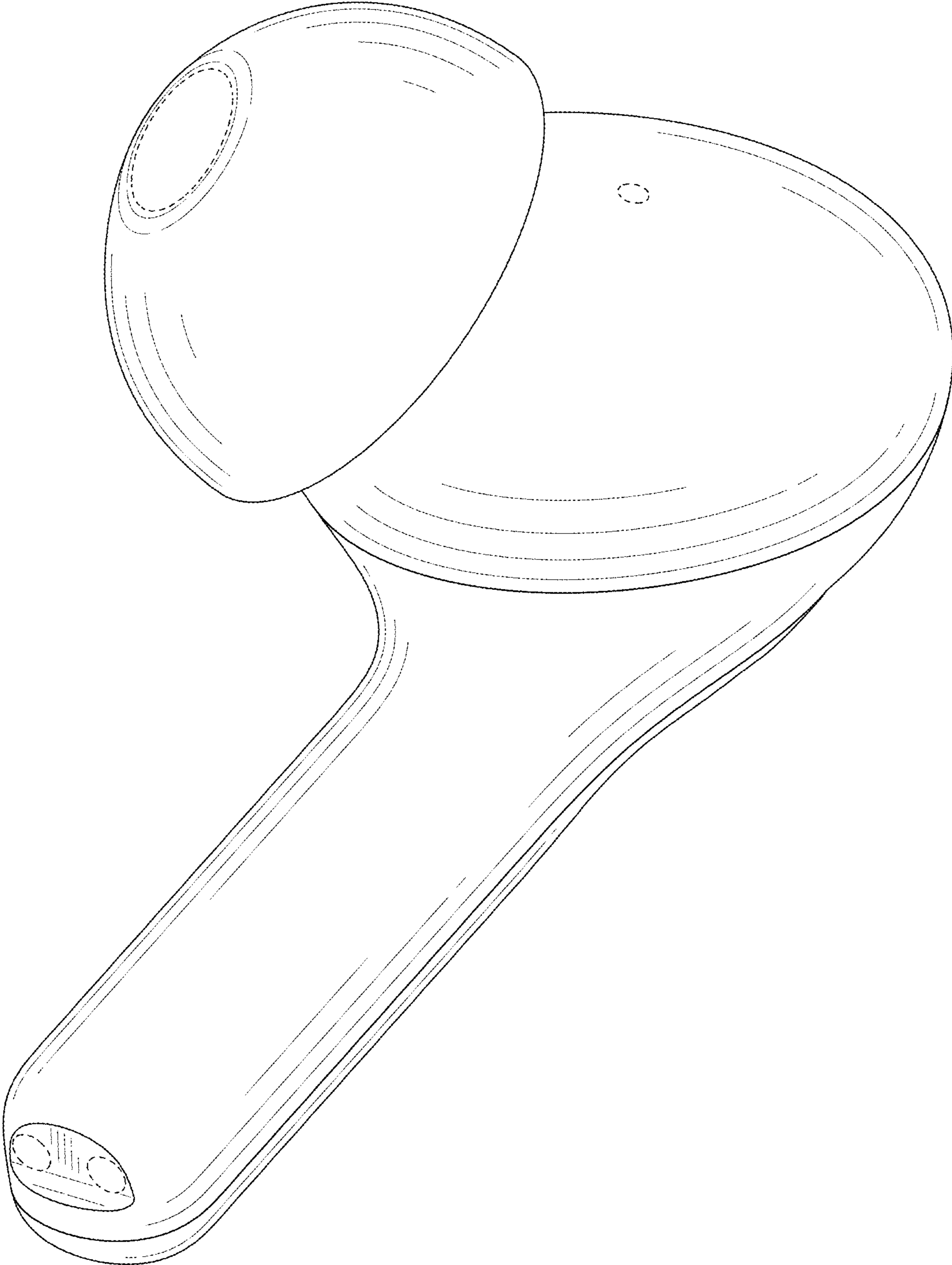


FIG. 10

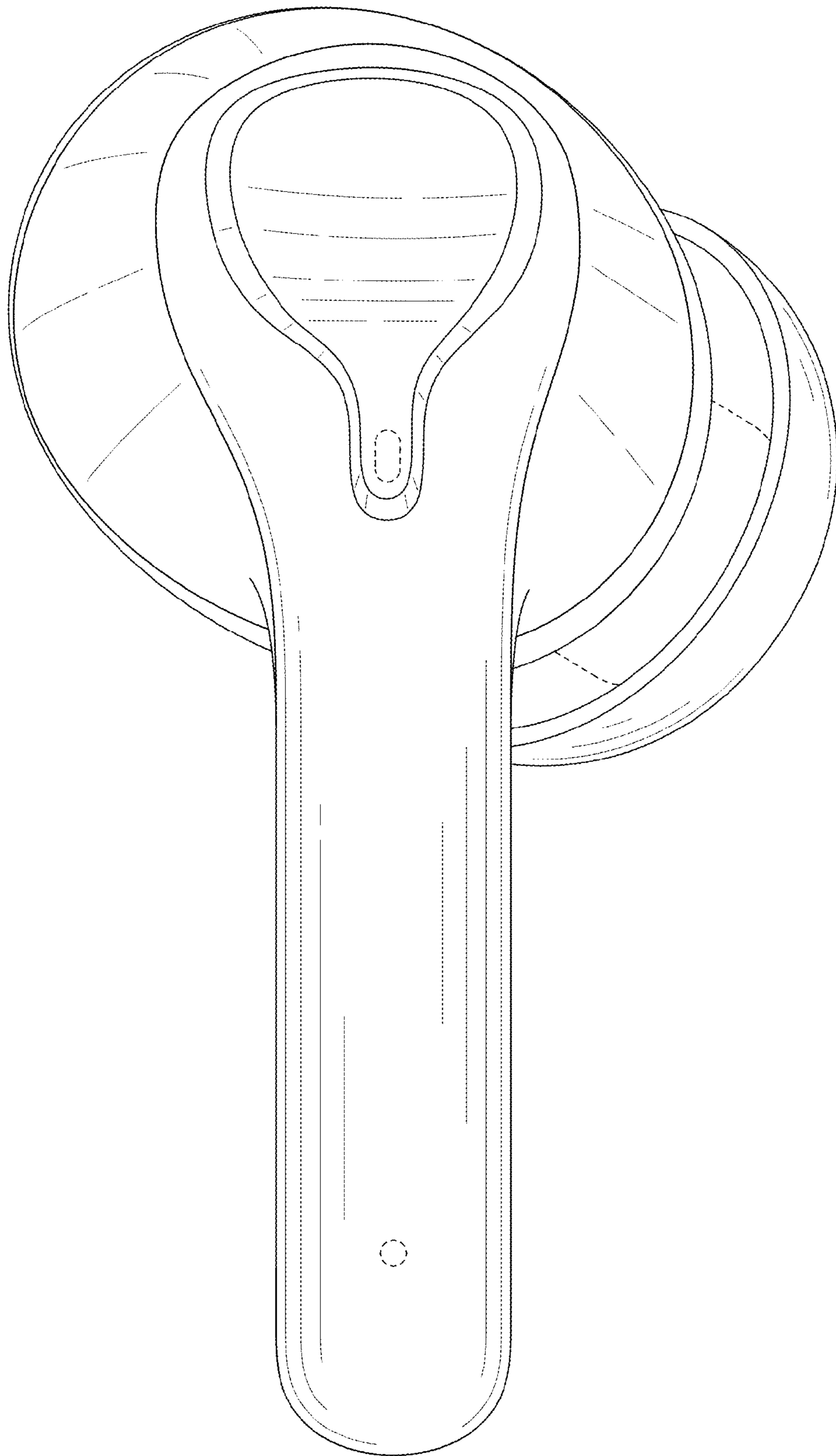


FIG. 11

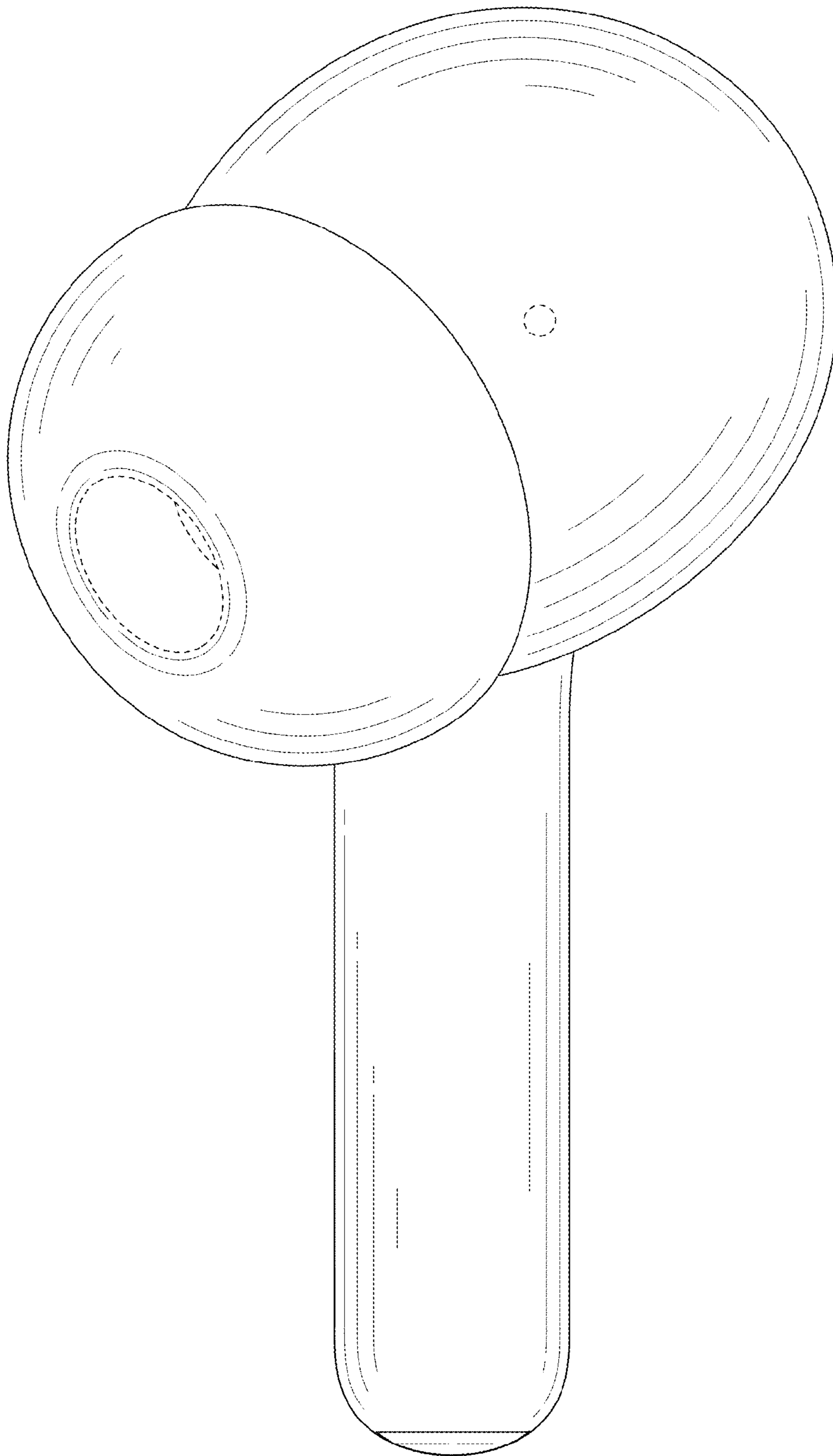


FIG. 12

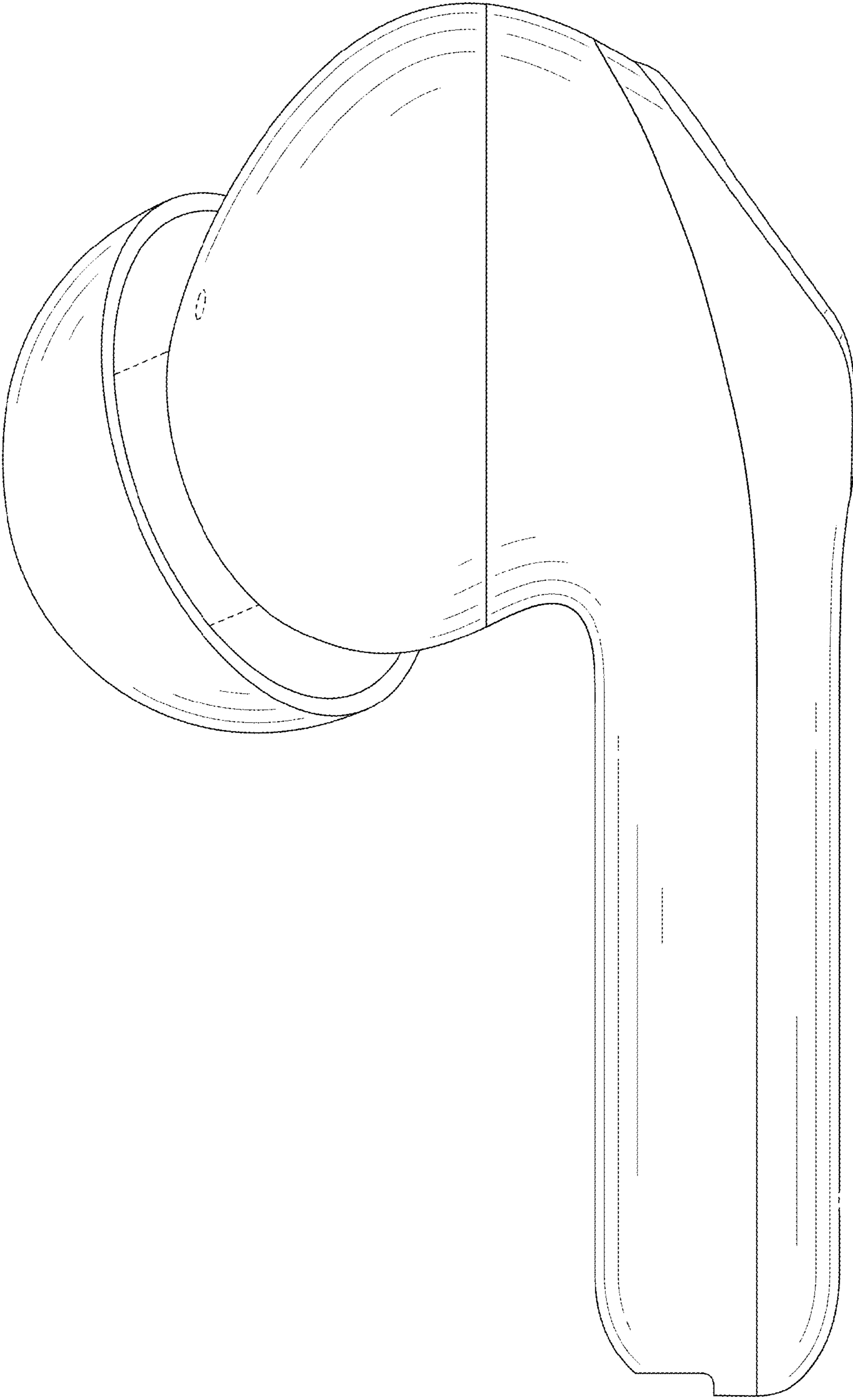


FIG. 13

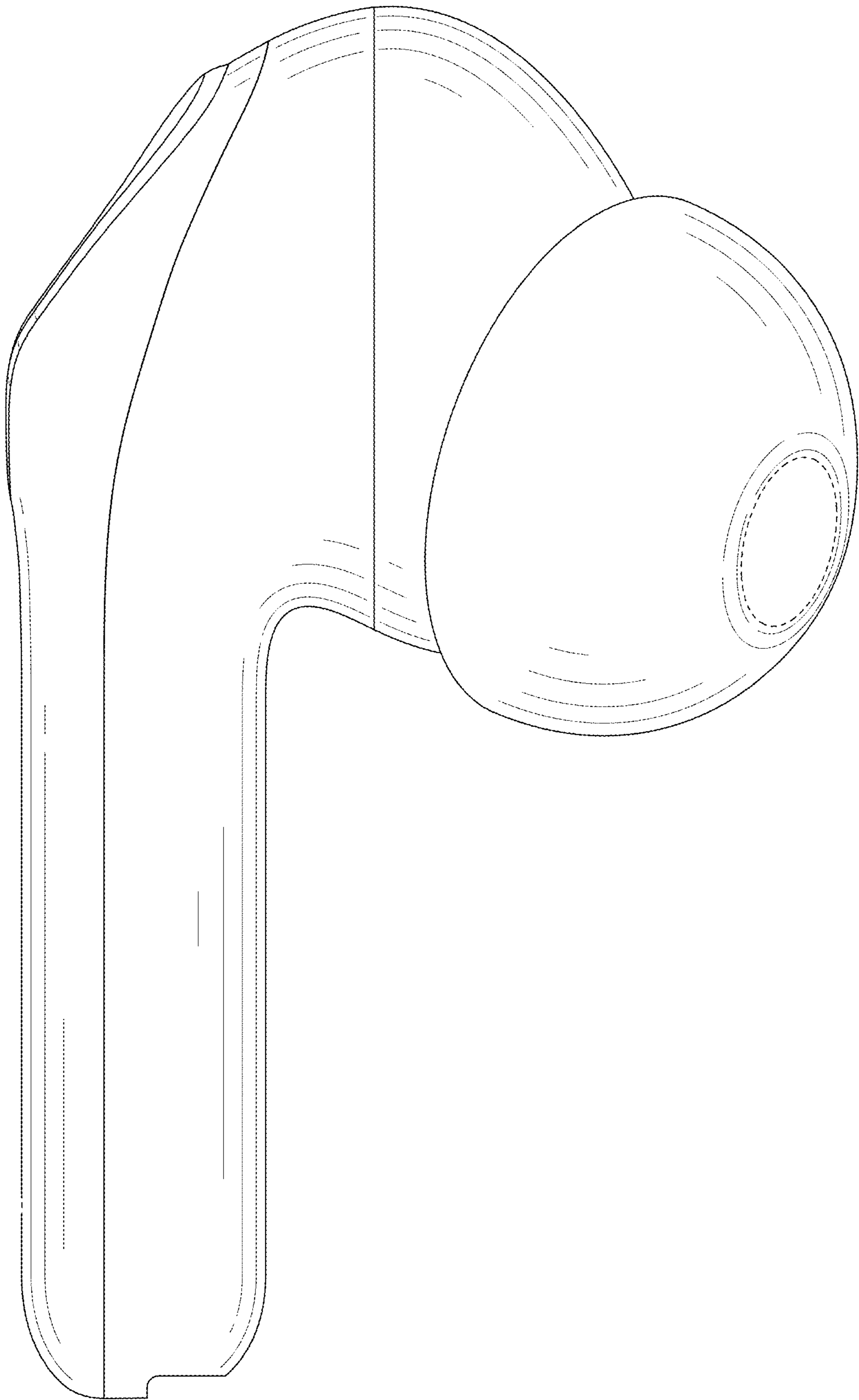


FIG. 14

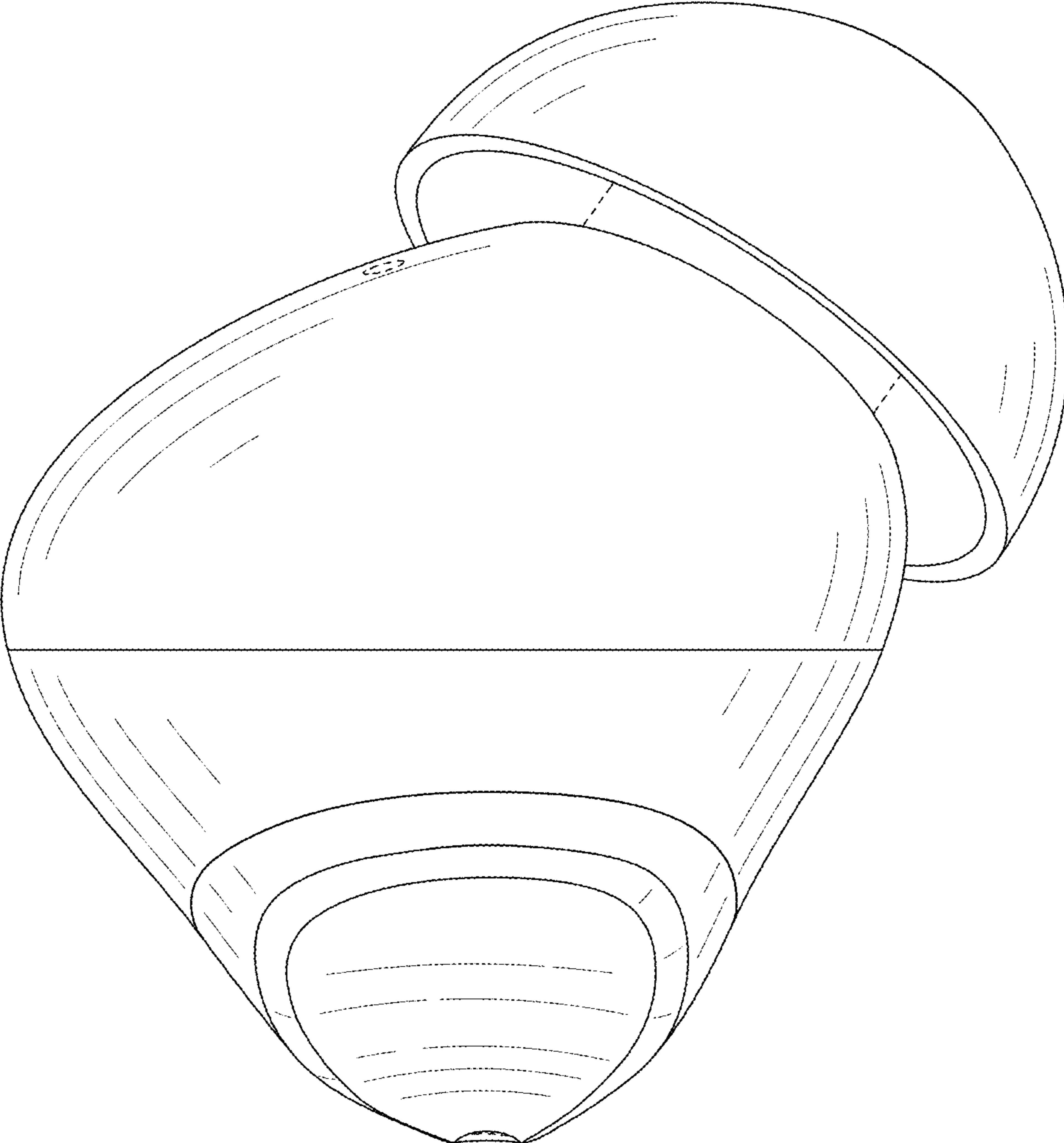


FIG. 15

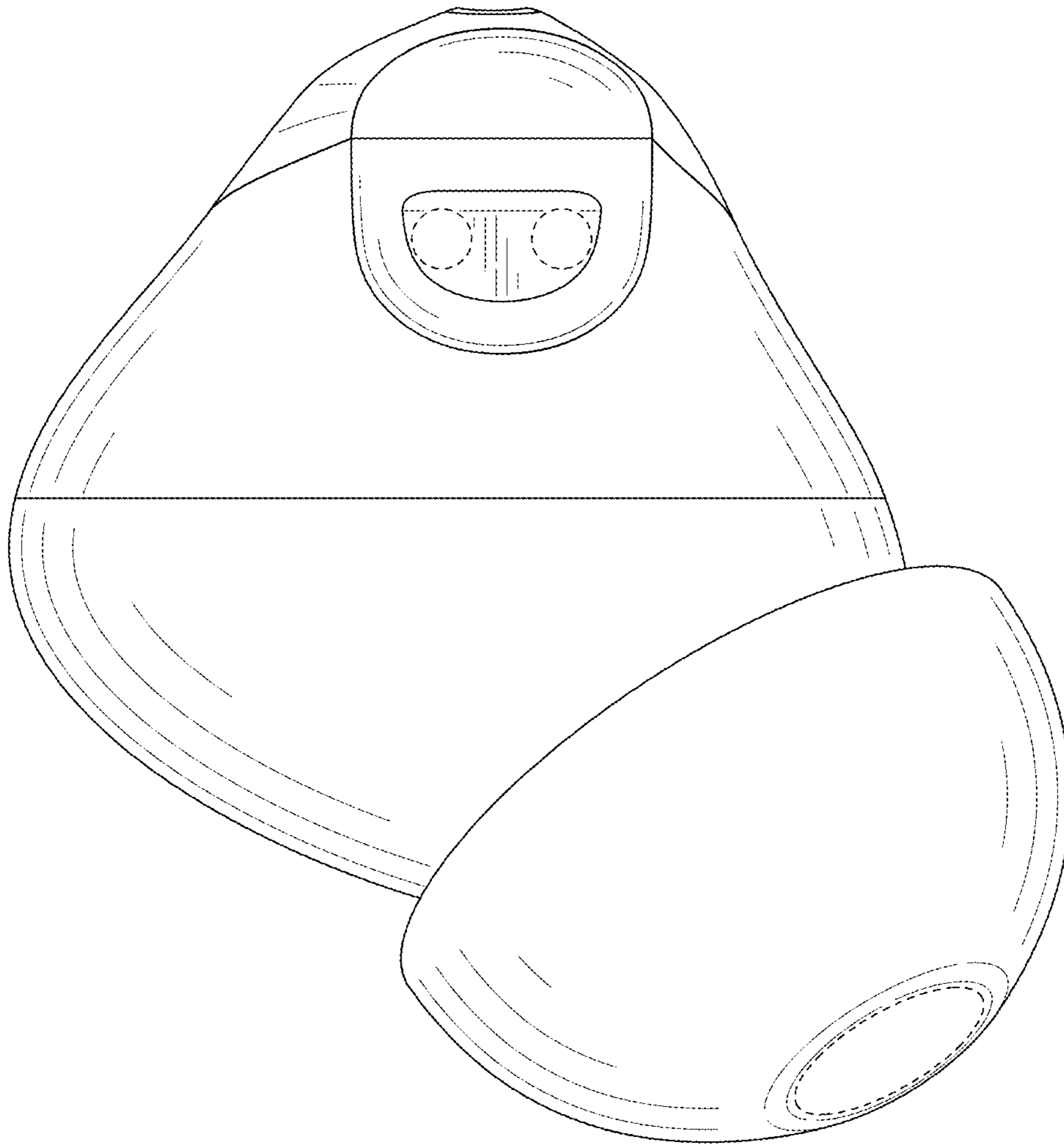


FIG. 16

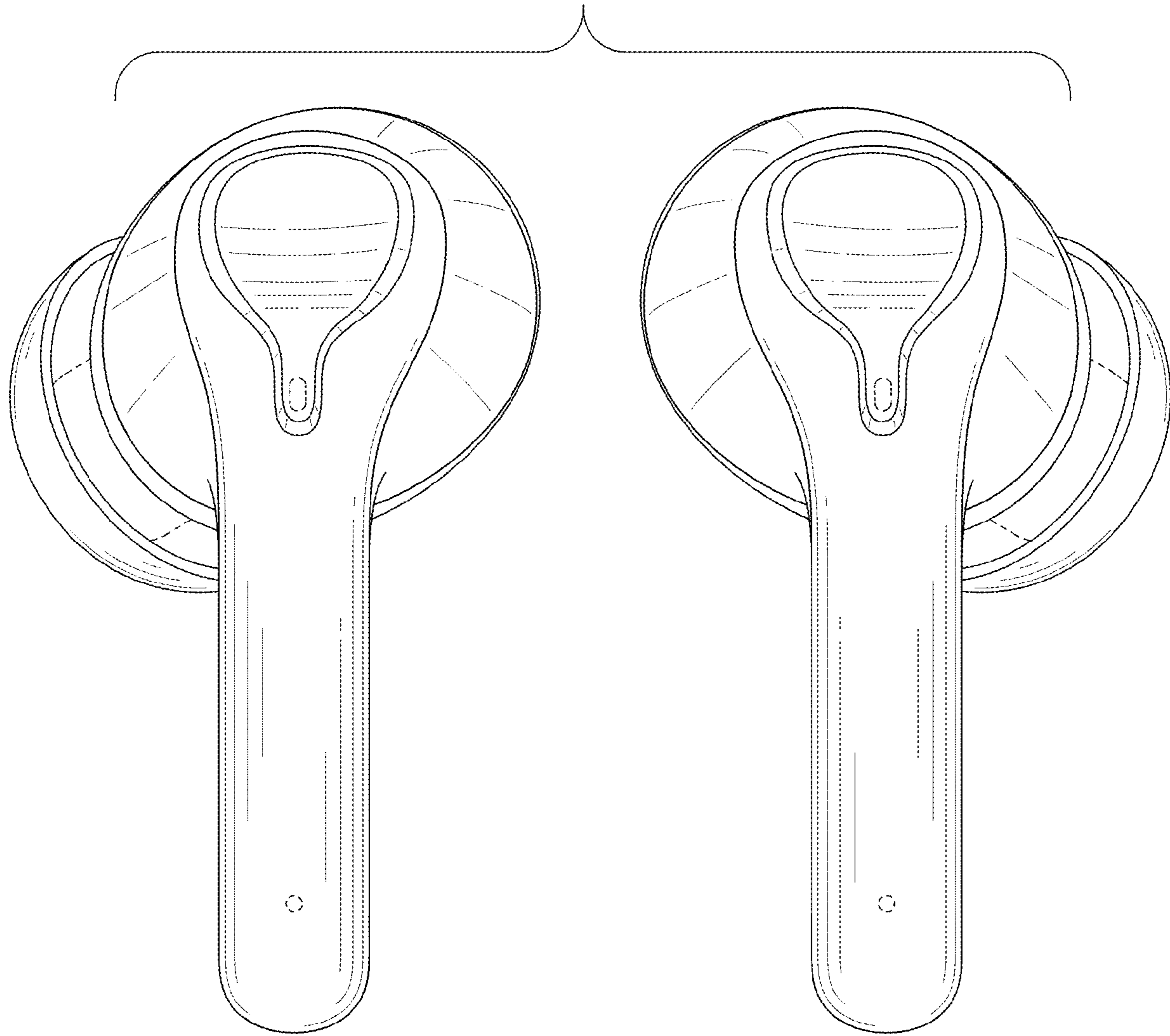


FIG. 17